

The GreenMOS[®] high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

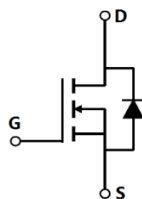
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Parameter	Value	Unit
$V_{DS, min} @ T_{j(max)}$	750	V
$I_D, pulse$	33	A
$R_{DS(ON), max} @ V_{GS}=10V$	360	
Q_g	20.6	nC

Product Name	Package	Marking
OSG70R360DSF	TO252	OSG70R360DS



Absolute Maximum Ratings at $T_j=25$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	700	V
Gate-source voltage	V_{GS}	± 30	V
Continuous drain current ¹⁾ , $T_C=25$ °C	I_D	11	A
Continuous drain current ¹⁾ , $T_C=100$ °C		7	
Pulsed drain current ²⁾ , $T_C=25$ °C	$I_{D, pulse}$	33	A
Continuous diode forward current ¹⁾ , $T_C=25$ °C	I_S	11	A
Diode pulsed current ²⁾ , $T_C=25$ °C	$I_{S, pulse}$	33	

Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C_{iss}		875.2		pF	$V_{GS}=0\text{ V}$, $V_{DS}=50\text{ V}$, 00 kHz
Output capacitance	C_{oss}		94.8		pF	
Reverse transfer capacitance	C_{rss}		2.9		pF	
Turn-on delay time	$t_{d(on)}$		25.7		ns	$V_{GS}=10\text{ V}$, $V_{DS}=400\text{ V}$, $R_G=2.5$ $I_D=10\text{ A}$
Rise time	t_r		25.9		ns	
Turn-off delay time	$t_{d(off)}$		58.4		ns	
Fall time	t_f		21		ns	

Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	Q_g		20.6		nC	$V_{GS}=10\text{ V}$, $V_{DS}=400\text{ V}$, $I_D=10\text{ A}$

Electrical Characteristics Diagrams

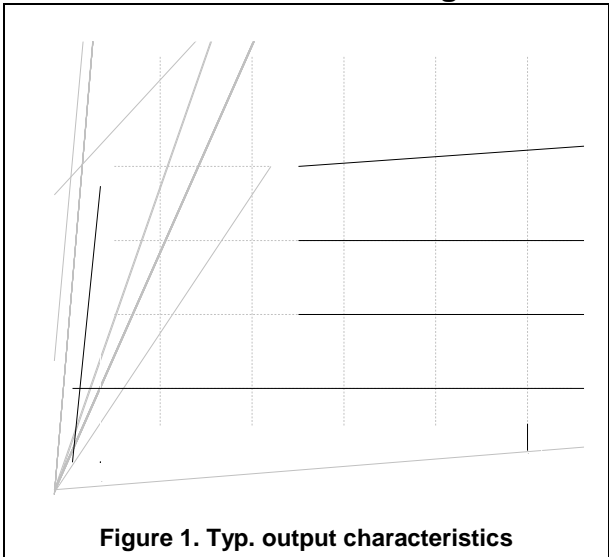


Figure 1. Typ. output characteristics

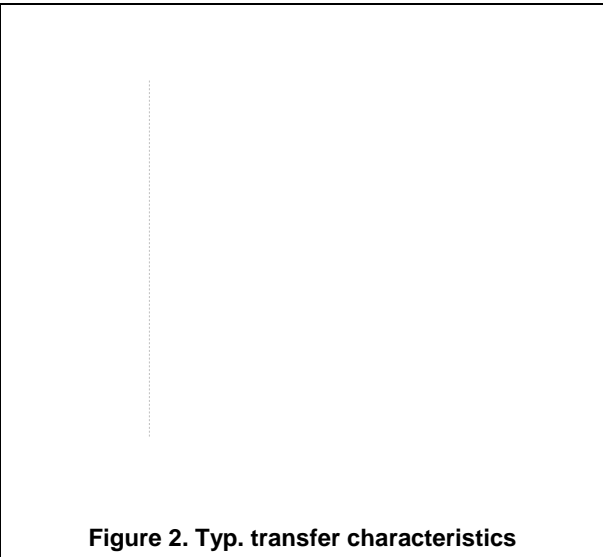


Figure 2. Typ. transfer characteristics

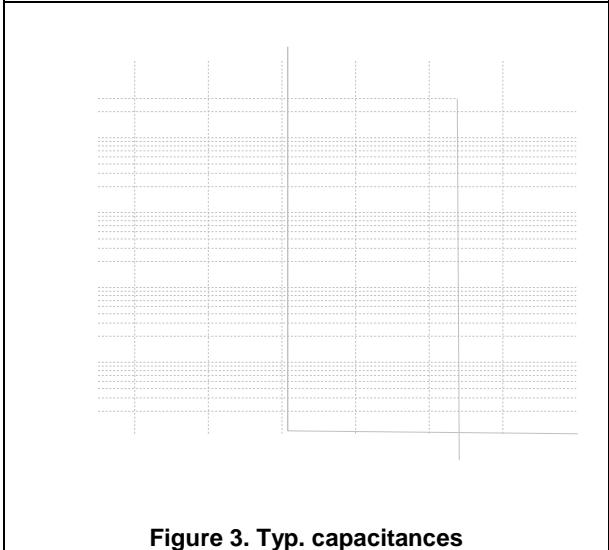


Figure 3. Typ. capacitances

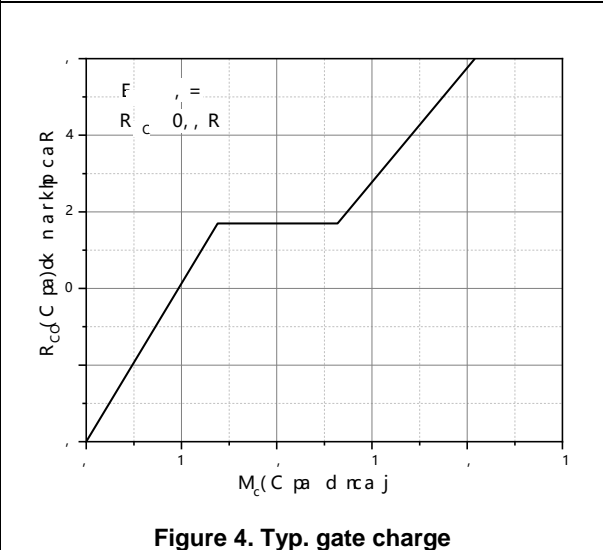


Figure 4. Typ. gate charge

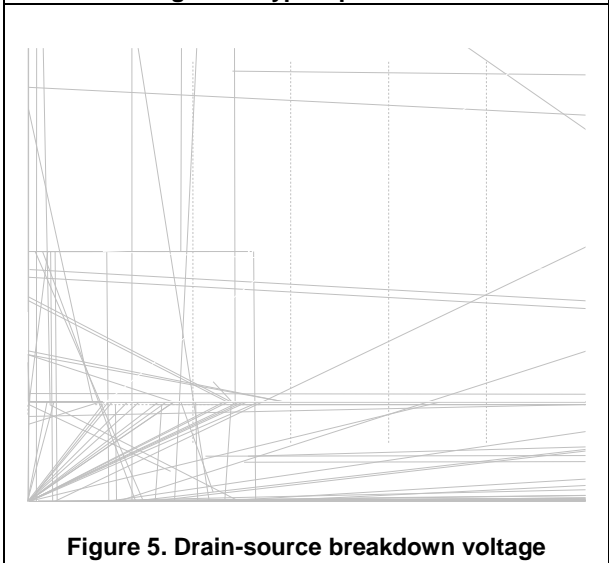


Figure 5. Drain-source breakdown voltage

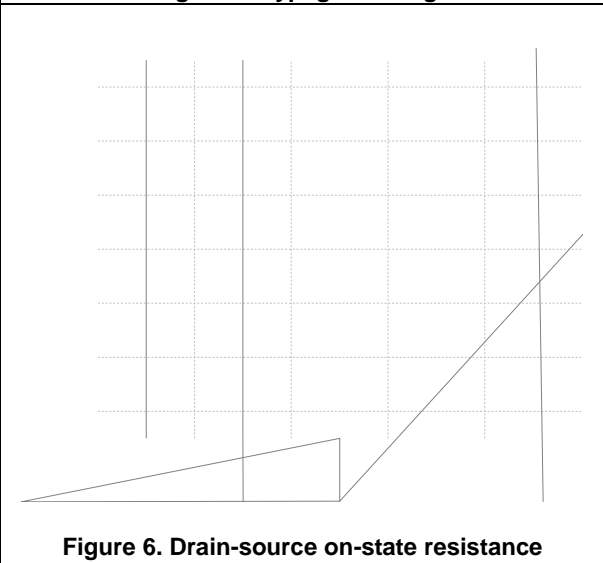


Figure 6. Drain-source on-state resistance

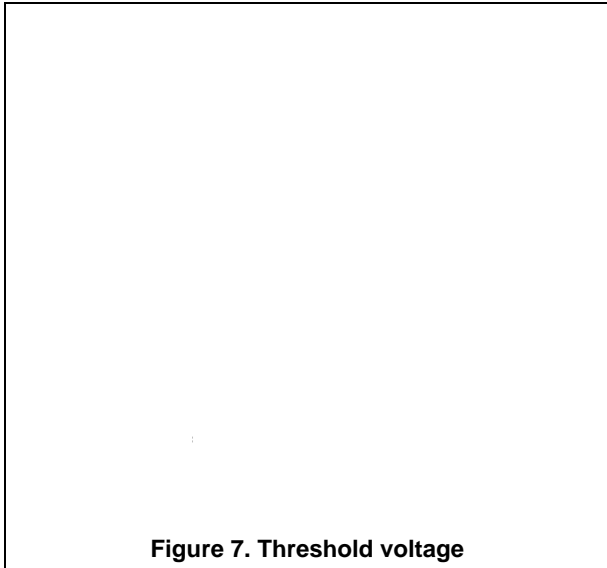


Figure 7. Threshold voltage

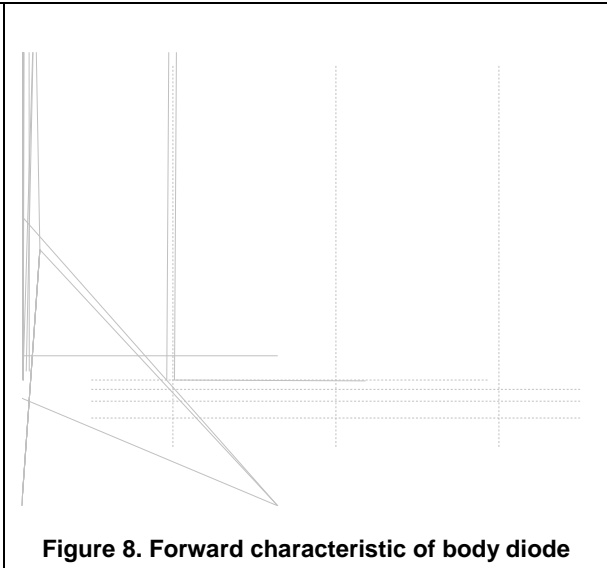


Figure 8. Forward characteristic of body diode

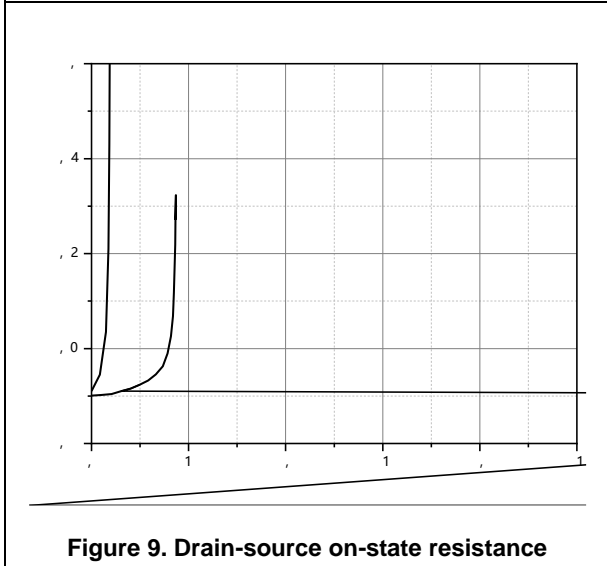


Figure 9. Drain-source on-state resistance

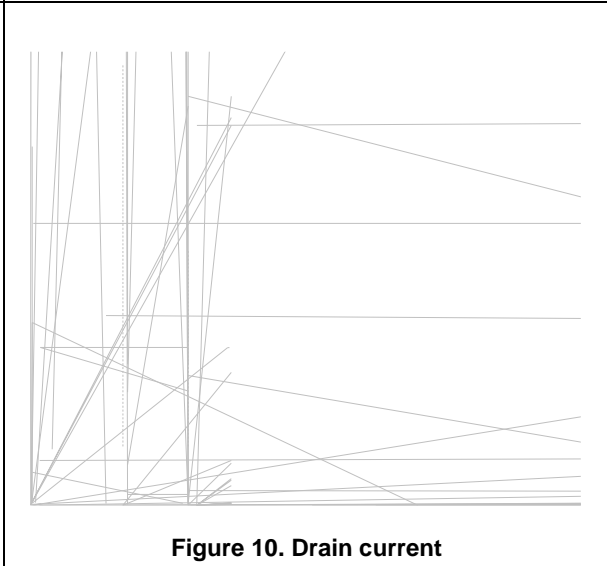


Figure 10. Drain current

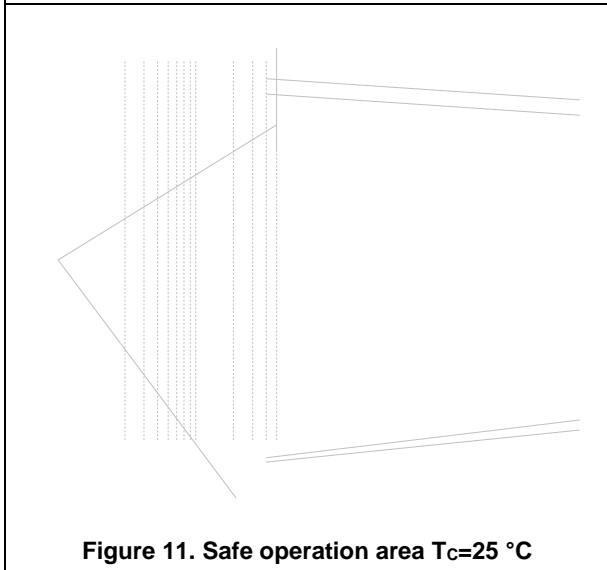


Figure 11. Safe operation area T_c=25 °C

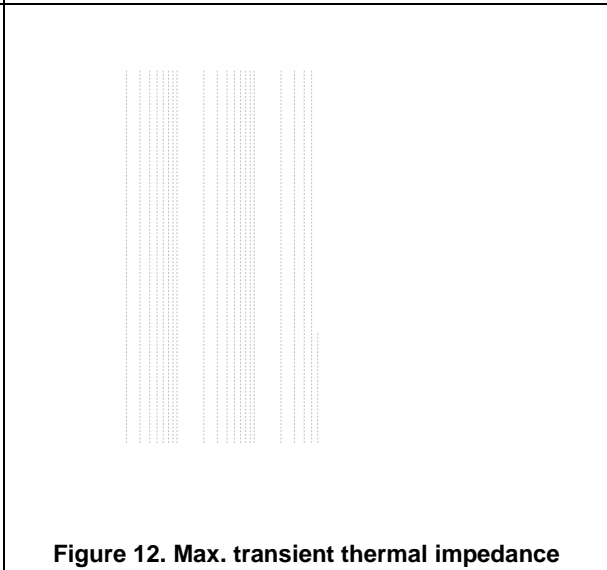


Figure 12. Max. transient thermal impedance

Test circuits and waveforms

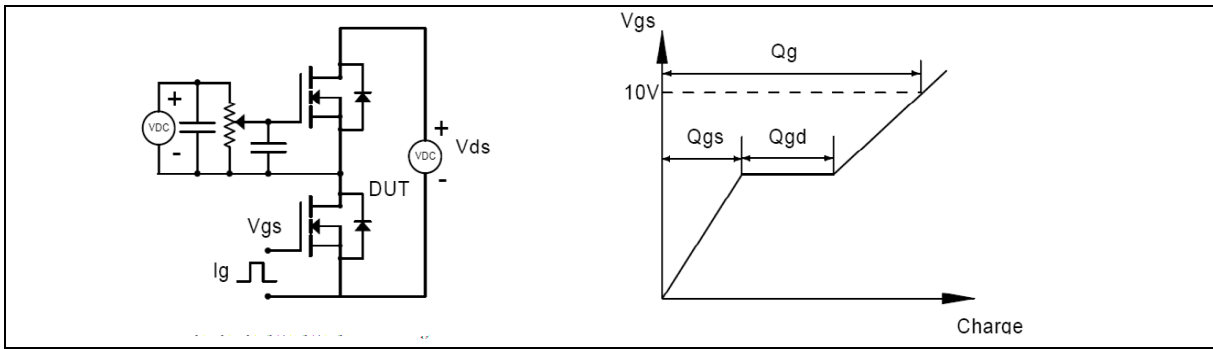


Figure 1. Gate charge test circuit & waveform



Figure 2. Switching time test circuit & waveforms

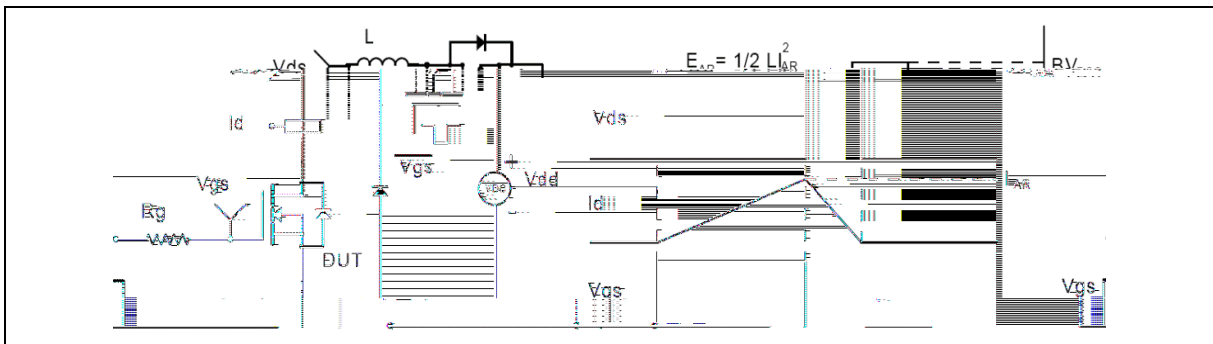


Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms

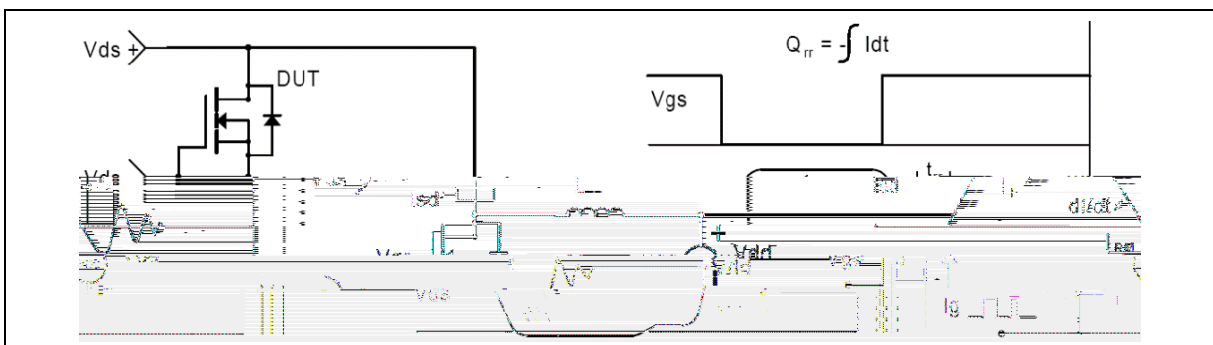


Figure 4. Diode reverse recovery test circuit & waveforms

Package Information

Symbol	mm		
	Min	Nom	Max
A	2.20	2.30	2.38
A1	0.00	-	0.10
A2	0.90	1.01	1.10
b	0.72	-	0.85
b1	0.71	0.76	0.81
b2	0.72	-	0.90
b3	5.13	5.33	5.46
c	0.47	-	0.60
c1	0.46		

Ordering Information

Package Type	Units/ Reel	Reels/ Inner Box	Units/ Inner Box	Inner Boxes/ Carton Box	Units/ Carton Box
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Product Information

Product	Package
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